

Mission Overview

- Develop and launch a 2U CubeSat into Low Earth Orbit (LEO)
- Execute research experiments in LEO for the payload: Variable Emissivity Device (VED)

COMMUNICATIONS



Figure 1: Embedded Communications 2nd Iteration of Transceiver Protoboard. Includes MCU and Transceiver chips

- Programming and installing an on-board transceiver system
- The transceiver consolidates all on-board data and packages for transmission.
- Ground station receives data and transmits commands to the satellite via a Software Defined Radio (SDR)

AVIONICS

- Utilizes a magnetorquer for attitude control
- Onboard computer runs with FreeRTOS on STM32 chip



Figure 2: Depiction of ADCS Bdot simulation



Figure 3: ADCS and CFC Software Hierarchy Diagram

PAYLOAD

- VED is a device that changes color and emissivity in response to varying voltage
- We want to test its performance in response to direct solar radiation.



Figure 4: Variable emissivity sample changing in response to solar radiation





ANTSAT 01



Figure 5: Preliminary SolidWorks model of AntSat 01

SPONSORS



ACKNOWLEDGEMENTS

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Figure 6: Panel deployment static sim

Developer Operations

- Create developer automations, server administration, and develop internal software tools.
- Implementing continuous integration pipeline to automatically test and statically analyzes firmware for MISRA C conformance

POWER

- Developing an Electric Power System (EPS) using battery cells, solar panels, and heaters
- EPS controls, regulates power budget, and maintains operational temperature.

CONCLUSION

Future Improvement

- Begin work on plans to integrate VED into satellite
- Develop testbeds to demo software
- improve deployment systems and conduct further testing Impact
- VED experiment will hopeful lead to accessible methods of thermal management on future spacecraft
- systems

CONTACT: Team Lead Adrian Osorio osorioaj@uci.edu

Faculty Advisor Professor David Copp

• Coordinate with other subsystems

Prototype panel deployment

systems integration

conditions.

to plan hardware deconflict during

mechanism and support structures

as well as conduct static, thermal,

and vibrational tests for launch

Figure 7: MISRA Logo

Figure 8: First iteration EPS PCB including headers for power input and output and control interface.

• Future generations of students to gain experience developing space